

Scaling Relations for Implantation of Size-Selected Au, Ag, and Si Clusters into Graphite

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The deposition of size-selected clusters represents a new route to the fabrication of truly nanometer-scale surface architectures, e.g., nanopores. We report a systematic experimental study, coupled with molecular dynamics simulations, of the implantation depths of size-selected Au₇, Ag₇, and Si₇ clusters in the model graphite substrate. For impact energies between 1.0 and 5.5 keV, we find that the implantation depth scales linearly with the momentum of the clusters for all three types of cluster. This “universal” behavior is consistent with a (viscous) retarding force proportional to the velocity of the cluster, akin to Stokes’s law.

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Ion-surface interactions play a crucial role in many surface processes and their applications [1–3]. When an atomic ion is incident upon a solid surface, the implantation depth depends upon the detailed impact parameters, e.g., the impact site within the surface unit cell, so that a distribution of depths results [4]. If the projectile ion is an atomic cluster larger than the surface unit cell, narrower depth distributions can be anticipated. For Ag₃[−] ions incident upon the model graphite surface, experiments and molecular dynamics (MD) simulations show that the implantation depth depends on the impact site and the orientation of the cluster as well as the kinetic energy [4]. However, when the cluster size is increased to $n = 7$ the implantation depth can be defined to within only one atomic layer of the substrate; the mean diameter of Ag₇ clusters, ~ 5.4 Å [5], already exceeds the unit cell size in graphite, 2.42 Å. Such a precise definition of the implantation depth for size-selected atomic clusters suggests the creation of novel nanoscale architectures, which may serve as model catalysts [6], prototypical binding sites to immobilize [7] biological molecules or nanoscale pores for DNA sequencing [8], or to create “molecular corrals” [9] by lateral etching.

The creation of such well-defined model nanostructures by the deposition of size-selected clusters requires us to develop a detailed understanding of the cluster-surface interaction [10], especially the scaling relations which govern cluster impact and implantation. In the case of the Ag_N/graphite system, significant progress has recently been reported [11–14]. For cluster sizes in the range $n = 50$ –200, the threshold energy for “pinning” of the incident cluster to the point of impact scales linearly with the cluster size. This process enables nanostructured surfaces to be fabricated which are stable against cluster diffusion even at room temperature and in the ambient [11]. Further, MD simulations for the size range $n =$

20–200 indicate an implantation depth, D , which scales linearly with the kinetic energy, E , and inversely with the cross-sectional area of the cluster; $D \propto E/N^{2/3}$ [12]. However, first experimental measurements for (smaller) Ag₇[−] clusters [13] indicate that the implantation depth scales with velocity, not energy, a difference which is also reflected in MD results [14]. In order to shed further light on the intriguing dynamics of the cluster-surface impact, we report in this Letter a systematic experimental study of the implantation depth of three different kinds of clusters, including both metal clusters, Au₇ and Ag₇, and semiconductor clusters, Si₇, into the graphite surface. The results show that, for elevated kinetic energies, the implantation depth scales with the *momentum* of the clusters in all cases. This universal behavior identified will enable the fabrication of precisely defined metallic and semiconductor nanostructures.

The size-selected clusters in this study were produced by two methods: with an rf magnetron sputtering, gas aggregation cluster source [11,15] in the case of Ag₇⁺, Au₇⁺, and Si₇⁺ clusters; and with a cesium sputtering source [16] for Ag₇[−] and Au₇[−]. The clusters were deposited in high vacuum ($\sim 10^{-7}$ mbar) onto highly oriented pyrolytic graphite (HOPG) samples, cleaved shortly before introduction to the vacuum. The impact energy of the clusters (in the range 1.0–5.5 keV) was determined by a bias voltage applied to the sample during deposition. The cluster implantation depths (more specifically, the damage track depths) were obtained by the etching method [17–23]. Thus the samples were etched in air at 650 °C for a duration of 3–5 min immediately after removal from the vacuum. The depth of the etch pits was measured using a bench-top scanning tunneling microscope (STM). The STM images were obtained with mechanically cut Pt/Ir tips; typical imaging parameters were a tip bias of 0.3–0.5 V and a tunneling current of 0.3–0.5 nA.

Figure 1(a) is a representative STM image showing the hexagonal etch pits formed by anisotropic lateral etching of a graphite sample implanted with Si_7^+ ions at 4.5 keV. Each cluster track generates an etch pit. Figure 1(b) shows a height profile along the white line marked in Fig. 1(a). From such data a distribution of etch pit depths for each cluster (Si_7 , Ag_7 , and Au_7) and each kinetic energy was obtained. Figure 2 shows graphs of the depth distributions for Si_7 implantation at 1.0, 2.5, and 4.5 keV (i.e., Fig. 1). The width of these distributions arises from a competition between lateral etching and defect annealing during the etching procedure; the cluster implantation depth corresponds to the deepest pits obtained for each combination of cluster composition and kinetic energy, extracted according to the recipe of Ref. [13], which gives excellent agreement with the results of MD simulations.

Figure 3 presents a compilation of the extensive data sets obtained for the implantation depths of Si_7 , Ag_7 , and Au_7 clusters over the kinetic energy range 0.5–5.5 keV. To within experimental error, the charge of the Au and Ag clusters (positive or negative) was found to have no effect upon the measured depth. Thus electronic braking [1] of the clusters plays a negligible role in these circumstances. To explore fully the appropriate scaling relations connecting the implantation depth to the dynamical parameters characterizing the incident clusters, Fig. 3 plots the experimental implantation depths as a function of three different parameters, the kinetic energy, Fig. 3(a), the velocity, Fig. 3(b), and the momentum, Fig. 3(c), of the clusters. Inspection of the graphs reveals immediately

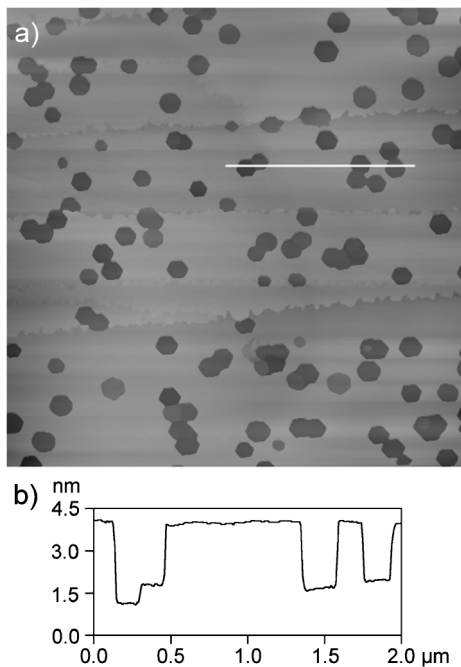


FIG. 1. (a) STM image ($5 \times 5 \mu\text{m}^2$) of the graphite surface showing etch pits created by oxidative etching after Si_7^+ cluster implantation at 4.5 keV. (b) Height profile corresponding to the white line in (a).

that, in the case of the Si clusters, a linear scaling is not obtained in any case. We return to this case below. For the Au and Ag clusters, comparison between Figs. 3(a) and 3(b) indicates that, in both cases, there is a linear relationship between the implantation depth and the velocity, not the kinetic energy, of the clusters (though the slopes are different). These results confirm the velocity scaling reported in the preliminary measurements of Ag_7^- implantation [13,14] and show that the same type of velocity scaling also applies to the Au_7 clusters (but not, at first sight, Si_7).

While Fig. 3(b) demonstrates that, for both Ag_7 and Au_7 clusters, the measured implantation depth (D) is linearly related to the cluster velocity, the different slopes indicate that at least one other factor must also play a role in the dynamics. Inspection of Fig. 3(c), in which the same implantation depth data are plotted against momentum (p), shows that in this case the slopes of the Au and Ag curves [24] are practically identical ($0.147 \pm 0.015 \text{ fsec u}^{-1}$ and $0.139 \pm 0.009 \text{ fsec u}^{-1}$, respectively). Thus the fundamental scaling relation, which unites the data for the Au and Ag clusters, is $D \propto p$. The nature of this scaling relationship also sheds light upon the nature of the force (F) experienced by the cluster in the graphite substrate; specifically, it is consistent with a braking force F which is proportional to the normal velocity (v) of the cluster, akin to Stokes's law. To prove this, suppose that $F \approx -bv$, where b is a constant. Then, integrating Newton's second law, from initial velocity v_0 at the point (above the surface) where the interaction starts ($x = \text{const}$) to $v = 0$ at depth $x = D$, yields simply

$$D = \frac{mv_0}{b} + \text{const.} \quad (1)$$

The linear relationship which results is consistent with the data for Au_7 and Ag_7 clusters, Fig. 3(c). The value of the constant will depend on the diameter of the clusters, since the interaction begins a distance above the surface

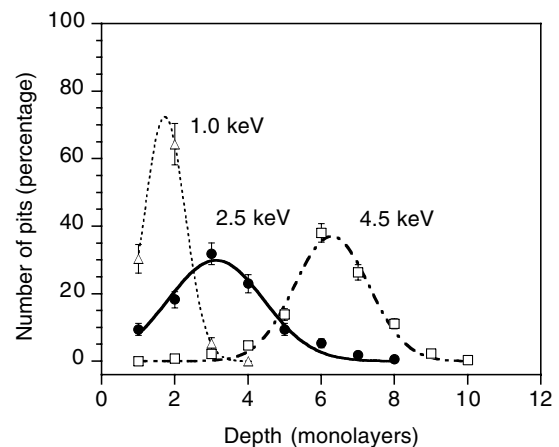


FIG. 2. The distribution of the etch pit depths obtained after implantation of Si_7^+ clusters into graphite at 1.0, 2.5, and 4.5 keV. The data are fitted to Gaussian distributions.

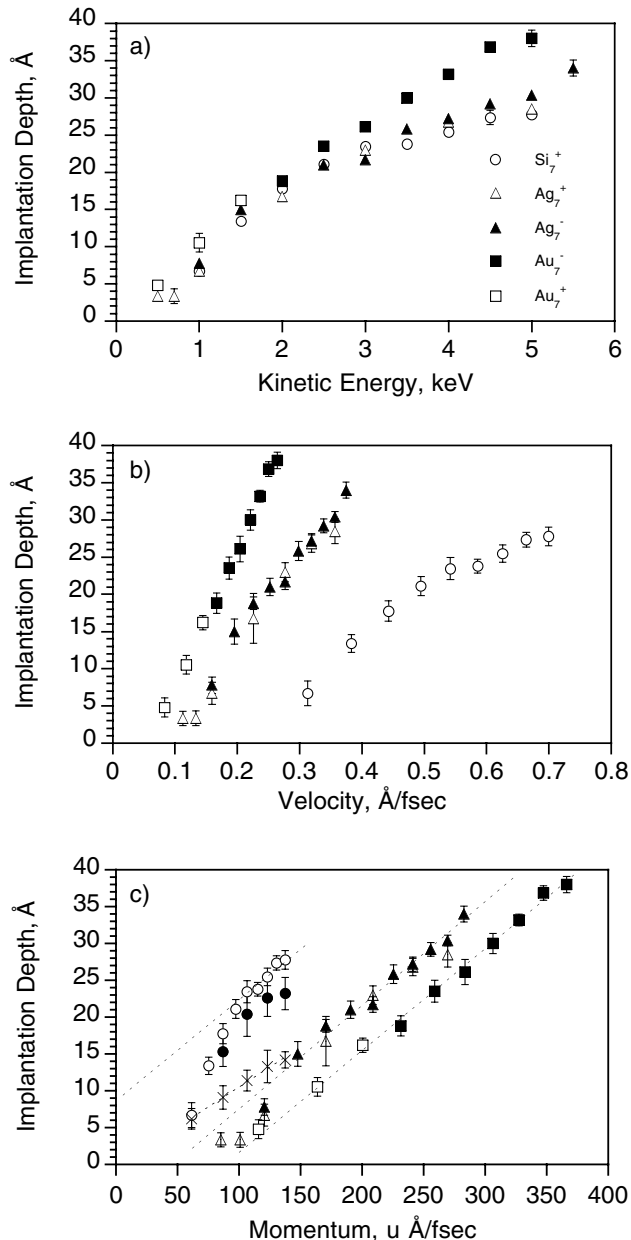


FIG. 3. The implantation depths for Au₇, Ag₇, and Si₇ clusters in graphite as a function of (a) kinetic energy, (b) velocity, and (c) momentum. The depths are given with respect to the top-most graphite layer. The data for Ag₇⁻ are obtained from Ref. [13]. In (c), the dashed lines are the best fit straight lines for Au₇ and Ag₇ (see text). The filled circles are the depths of the damage tracks from MD simulations for Si₇. The crosses are the calculated center-of-mass cluster implantation depths.

of the order of the cluster radius. However, Au₇ and Ag₇ clusters have similar size, and the different (extrapolated) intercepts most likely relate to the threshold energy required to create the first defect in the top graphite layer (equivalent to the pinning energy discussed in Ref. [11]).

We have noted already that the measured behavior of the Si₇ clusters, Fig. 3(c), does not follow the same linear dependence on momentum which is true of Au₇ and Ag₇. Indeed, Fig. 3 shows that the Si₇ implantation depths do

not simply scale with any of the dynamical parameters plotted. However, closer inspection of Fig. 3(c) shows that, for higher energies (momenta), the Si data can be represented by a straight line with the same slope as the Au and Ag data. Thus, in the high energy regime, there is a universal behavior which unites the metal clusters, Au₇ and Ag₇, with the semiconductor cluster, Si₇. It appears that the same (viscous) retarding force, Eq. (1), operates in all cases. Why then should silicon depart from this common behavior at lower energies?

To explore further the behavior of the Si₇ clusters, we have conducted MD simulations [14] of their implantation into graphite. The Brenner potential [25] was employed for graphite, together with interlayer terms [26], while Si and SiC were treated by the Tersoff potential [27,28]. The Ziegler-Biersack-Littmark (ZBL) screened Coulomb potential [29] was employed to represent the short range repulsive potential. Figure 4 shows MD simulations for Ag₇ and Si₇ clusters deposited at 4 keV after completion of the collisional phase of the cascade. One key point which emerges from the simulations is that, in the case of Si (but not Ag), the damage track in the graphite substrate extends a few layers below the cluster itself, attributed to the creation of high energy carbon recoils. Since the etching method measures the depth of the damage track, and not the implantation depth of the cluster itself, the MD simulations imply that the data of Figs. 2 and 3 will overestimate the true implantation depths for silicon. Thus in Fig. 3(c) we plot the depth of the etch pits for Si₇ predicted from the MD simulations for four different energies, 2, 3, 4, and 5 keV (filled circles). The agreement with the experimental etch pit depths is very good. We also plot in Fig. 3(c) the (center of mass) implantation depths of the Si₇ clusters extracted from the MD simulations. The slope of the line through these points is 0.108 ± 0.024 fsec u⁻¹. This is in rather good agreement with the experimental slopes for Ag₇ and Au₇. We conclude that the Si₇ clusters follow the same

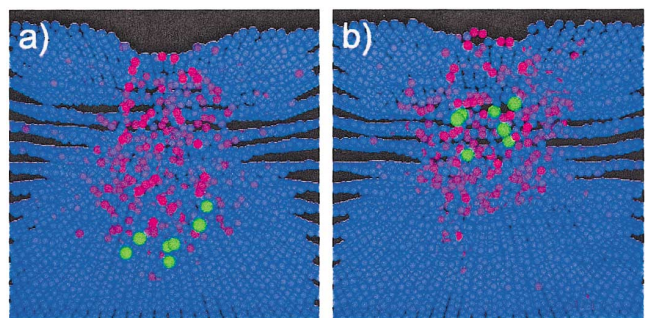


FIG. 4 (color). Snapshot from MD simulations of cluster implantation into graphite, after completion of the collisional phase, for normally incident, seven-atom clusters at 4 keV. (a) Ag₇ cluster; (b) Si₇ cluster. In (b) there is more damage underneath the implanted cluster, caused by recoil C atoms. Note also the sputtered C atom above the surface in this case. The cluster atoms are shown in green.

universal scaling behavior as the metal clusters and that the “anomalous” behavior of the experimental etch pit depths arises from the creation of energetic carbon recoils which extend the depth of the damage track.

Why should the creation of the energetic carbon recoils be different for Si₇ than Au₇ and Ag₇? The reason is a pure mass effect. Our MD simulations show that the covalent attraction between the C and Si atoms (the Si-C bond energy is 4.6 eV in SiC [30], while the Ag adsorption energy on graphite lies in the range 0.23 to 0.54 eV [31]) has a negligible effect on the implantation depths. If the mass of the Si atom is artificially increased to that of Ag, but with the covalent Si-C interaction unchanged, almost exactly the same results are found as for Ag itself [14]. The mass effect is illustrated by the fact that the maximum energy transfer in a binary collision between a Ag atom of incident energy E_0 and a C atom at rest is $0.36E_0$, whereas for an incident Si atom it is $0.84E_0$. Thus higher energy carbon recoils can be created by the Si cluster, and some of these recoils cause damage deeper into the graphite substrate than the cluster itself. This effect saturates, Fig. 3(c), at high energies (momenta).

In summary, we have reported a systematic experimental study of the implantation depths of size-selected Au₇, Ag₇, and Si₇ clusters in the model graphite substrate. A strikingly uniform behavior is observed, particularly at elevated impact energies, where the implantation depth is found to scale linearly with the momentum of the clusters in all three cases. We have also shown that this behavior is consistent with a retarding force proportional to the velocity of the cluster, akin to Stokes’s law. In the case of Si₇, the measured depth of the damage track exceeds the true cluster implantation depth, because of the creation of energetic recoil atoms. The data and model presented establish a “universality” in the implantation behavior of size-selected clusters which can be exploited to create well-defined, truly nanometer-scale architectures (“cluster down a well”) for applications in single molecule physics, chemistry, and biology. In this case the lateral dimensions of the “pore” will be controlled by the cluster size and the depth determined by the kinetic energy, via the scaling relations which have been established. Future work needs to establish experimentally whether larger clusters (10–1000 atoms) follow the same scaling relations.

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- [1] R. Smith, *Atomic and Ion Collisions in Solids and at Surfaces* (Cambridge University Press, Cambridge, U.K., 1997).
- [2] T. S. Wand *et al.*, Appl. Phys. Lett. **77**, 3586 (2000); P. M. Voyles, D. A. Muller, J. L. Grazul, P. H. Citrin, and H. J. L. Gossmann, Nature (London) **416**, 826 (2002)
- [3] G. Costantini *et al.*, Phys. Rev. Lett. **86**, 838 (2001); S. Rusponi *et al.*, Phys. Rev. Lett. **81**, 4184 (1998).
- [4] S. J. Carroll *et al.*, Phys. Rev. Lett. **81**, 3715 (1998).
- [5] R. Fournier, J. Chem. Phys. **115**, 2165 (2001).
- [6] S. Abbet *et al.*, Phys. Rev. Lett. **86**, 5950 (2001); C. R. Henry, Surf. Sci. Rep. **31**, 235 (1998); M. Valden, X. Lai, and D. W. Goodman, Science **281**, 1647 (1998); U. Heiz *et al.*, J. Am. Chem. Soc. **121**, 3214 (1999).
- [7] M. B. Viani *et al.*, Nat. Struct. Biol. **7**, 644 (2000).
- [8] J. Li *et al.*, Nature (London) **412**, 166 (2001).
- [9] D. L. Patrick, V. J. Cee, and T. P. Beebe, Science **265**, 231 (1994).
- [10] C. Brechignac *et al.*, Phys. Rev. Lett. **88**, 196103 (2002); B. Kaiser *et al.*, Phys. Rev. Lett. **83**, 2918 (1999); J. Schmelzer *et al.*, Phys. Rev. Lett. **88**, 226802 (2002).
- [11] S. J. Carroll *et al.*, J. Chem. Phys. **113**, 7723 (2000); M. Helmer, Nature (London) **408**, 531 (2000).
- [12] S. J. Carroll *et al.*, Phys. Rev. Lett. **84**, 2654 (2000).
- [13] D. J. Kenny *et al.*, J. Phys. Condens. Matter **14**, L185 (2002).
- [14] C. F. Sanz-Navarro *et al.*, Phys. Rev. B **65**, 165420 (2002).
- [15] S. J. Carroll, Ph.D. thesis, The University of Birmingham, 1999; B. von Issendorff and R. E. Palmer, Rev. Sci. Instrum. **70**, 4497 (1999).
- [16] S. G. Hall *et al.*, Rev. Sci. Instrum. **68**, 3335 (1997).
- [17] H. Chang and A. J. Bard, J. Am. Chem. Soc. **113**, 5588 (1991).
- [18] J. R. Hahn and H. Kang, Surf. Sci. **446**, L77 (2000).
- [19] D. J. Kenny *et al.*, Eur. Phys. J. D **16**, 115 (2001).
- [20] C. T. Reimann *et al.*, Nucl. Instrum. Methods Phys. Res., Sect. B **140**, 159 (1998).
- [21] G. Bräuchle *et al.*, Appl. Phys. Lett. **67**, 52 (1995).
- [22] R. P. Webb *et al.*, Nucl. Instrum. Methods Phys. Res., Sect. B **122**, 318 (1997).
- [23] H. Hövel *et al.*, Phys. Rev. Lett. **81**, 4608 (1998).
- [24] The slopes were obtained by a least squares fit to all the data points above a kinetic energy of 1 keV for both the Au and Ag clusters.
- [25] D. W. Brenner, Phys. Rev. B **42**, 9458 (1990); **46**, 1948 (1992).
- [26] R. Smith and K. Beardmore, Thin Solid Films **272**, 255 (1996).
- [27] J. Tersoff, Phys. Rev. B **42**, 9458 (1990).
- [28] K. Beardmore and R. Smith, Philos. Mag. **74**, 1439 (1996).
- [29] J. F. Ziegler, J. P. Biersack, and U. Littmark, *The Stopping and Range of Ions in Solids* (Pergamon, New York, 1985).
- [30] K. P. Huber and G. Herzberg, *Molecular Spectra and Molecular Structure IV: Constants of Diatomic Molecules* (Van Nostrand Reinhold, New York, 1979), p. 594.
- [31] D. M. Duffy and J. A. Blackman, Surf. Sci. **415**, L1016 (1998).